



State-of-the-Art Technology and Application of Hyperspectral Imaging

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Message from the Guest Editor

This Special Issue focuses on state-of-the-art research of hyperspectral imaging in various industrial applications. Accordingly, papers that demonstrate novel hyperspectral imaging technology concepts dealing with theoretical analyses, laboratory, and field studies in various industries, such as agriculture, remote sensing, defense, security, pharmacy, and biotechnology, etc., are welcomed.

We would like to invite you to submit original research papers and reviews for the “State-of-the-Art Technology and Application of Hyperspectral Imaging” Special issue.





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Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal Applied Sciences has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

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